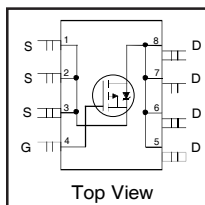


HEXFET® Power MOSFET

**Features**

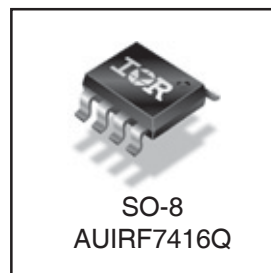
- Advanced Process Technology
- Low On-Resistance
- Logic Level Gate Drive
- P-Channel MOSFET
- Dynamic  $dV/dt$  Rating
- 150°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free, RoHS Compliant
- Automotive Qualified\*



$V_{(BR)DSS}$	<b>-30V</b>
$R_{DS(on)}$ max.	<b>0.02Ω</b>
$I_D$	<b>-10A</b>

**Description**

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
AUIRF7416Q	SO-8	Tube	95	AUIRF7416Q
		Tape and Reel	2500	AUIRF7416QTR

**Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_A$ ) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_D$ @ $T_A = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ -10V	-10	A
$I_D$ @ $T_A = 70^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ -10V	-7.1	
$I_{DM}$	Pulsed Drain Current ①	-45	
$P_D$ @ $T_A = 25^\circ\text{C}$	Power Dissipation	2.5	W
	Linear Derating Factor	0.02	mW/°C
$V_{GS}$	Gate-to-Source Voltage	± 20	V
$E_{AS}$	Single Pulse Avalanche Energy②	370	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ ③	-5.0	V/ns
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to + 150	°C

**Thermal Resistance**

	Parameter	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient ④	50	°C/W

HEXFET® is a registered trademark of International Rectifier.

\*Qualification standards can be found at <http://www.irf.com/>

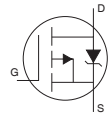
**Static Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	-30	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	-0.024	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = -1mA$
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	0.020	$\Omega$	$V_{GS} = -10V, I_D = -5.6A$ ④
		—	—	0.035		$V_{GS} = -4.5V, I_D = -2.8A$ ④
$V_{GS(th)}$	Gate Threshold Voltage	-1.0	—	-2.04	V	$V_{DS} = V_{GS}, I_D = -250\mu A$
$g_{fs}$	Forward Transconductance	5.6	—	—	S	$V_{DS} = -10V, I_D = -2.8A$
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	-1.0	$\mu A$	$V_{DS} = -24V, V_{GS} = 0V$
		—	—	-25		$V_{DS} = -24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	-100	nA	$V_{GS} = -20V$
	Gate-to-Source Reverse Leakage	—	—	100		$V_{GS} = 20V$

**Dynamic Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge	—	61	92	nC	$I_D = -5.6A$
$Q_{gs}$	Gate-to-Source Charge	—	8.0	12		$V_{DS} = -24V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	22	32		$V_{GS} = -10V$ , See Fig. 6 & 9 ④
$t_{d(on)}$	Turn-On Delay Time	—	18	—	ns	$V_{DD} = -15V$
$t_r$	Rise Time	—	49	—		$I_D = -5.6A$
$t_{d(off)}$	Turn-Off Delay Time	—	59	—		$R_G = 6.2\Omega$
$t_f$	Fall Time	—	60	—		$R_D = 2.7\Omega$ , See Fig. 10 ④
$C_{iss}$	Input Capacitance	—	1700	—	pF	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	890	—		$V_{DS} = -25V$
$C_{rss}$	Reverse Transfer Capacitance	—	410	—		$f = 1.0MHz$ , See Fig. 5

**Diode Characteristics**

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	-3.1	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ①	—	—	-45		
$V_{SD}$	Diode Forward Voltage	—	—	-1.0	V	$T_J = 25^\circ\text{C}, I_S = -5.6A, V_{GS} = 0V$ ③
$t_{rr}$	Reverse Recovery Time	—	56	85	ns	$T_J = 25^\circ\text{C}, I_F = -5.6A$
$Q_{rr}$	Reverse Recovery Charge	—	99	150	nC	$di/dt = 100A/\mu s$ ③

**Notes:**

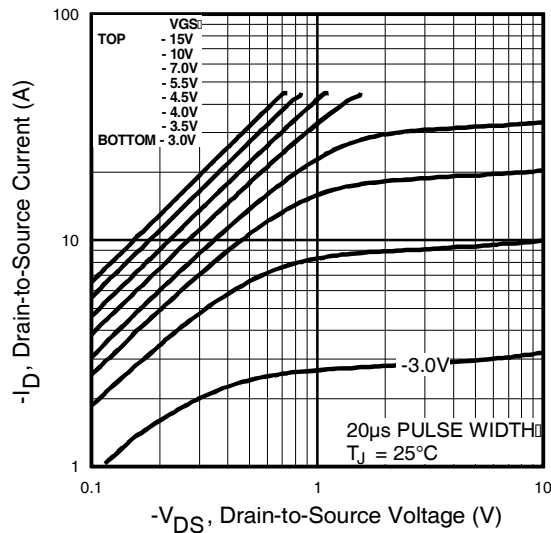
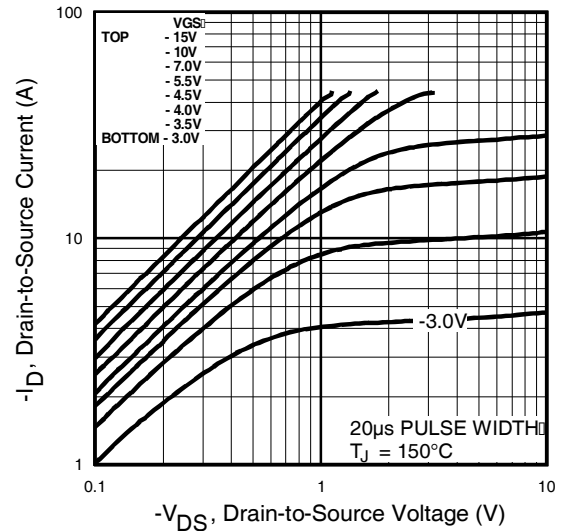
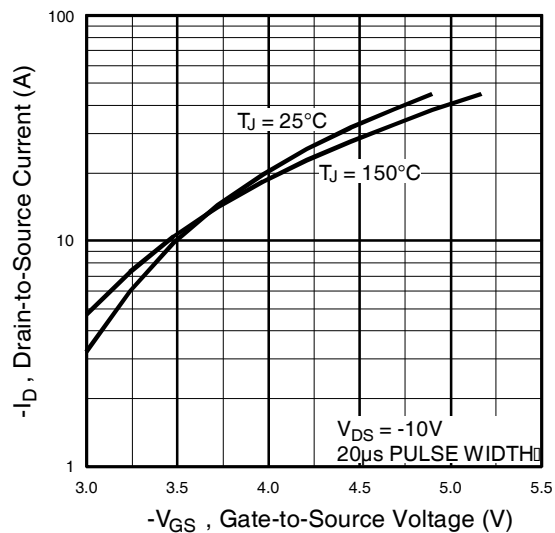
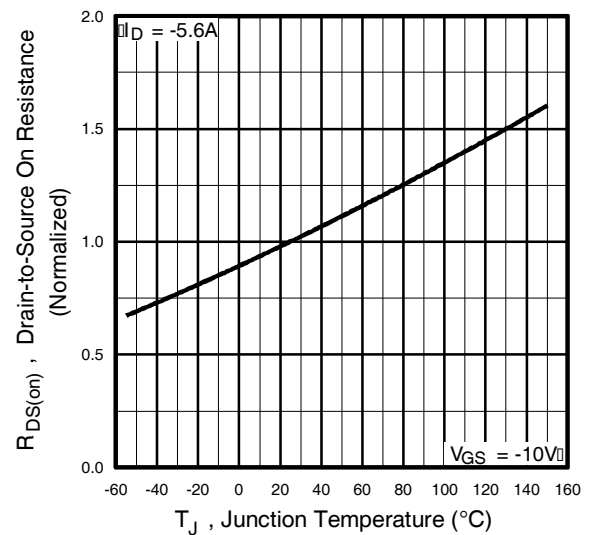
① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )

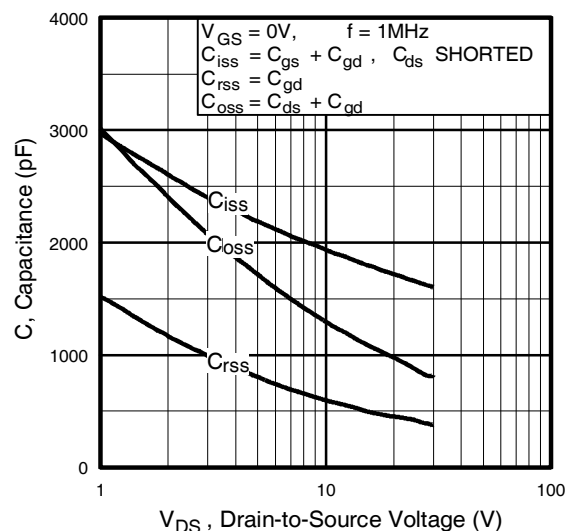
② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 25mH$   
 $R_G = 25\Omega$ ,  $I_{AS} = -5.6A$ . (See Figure 12)

③  $I_{SD} \leq -5.6A$ ,  $di/dt \leq 100A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  
 $T_J \leq 150^\circ\text{C}$ .

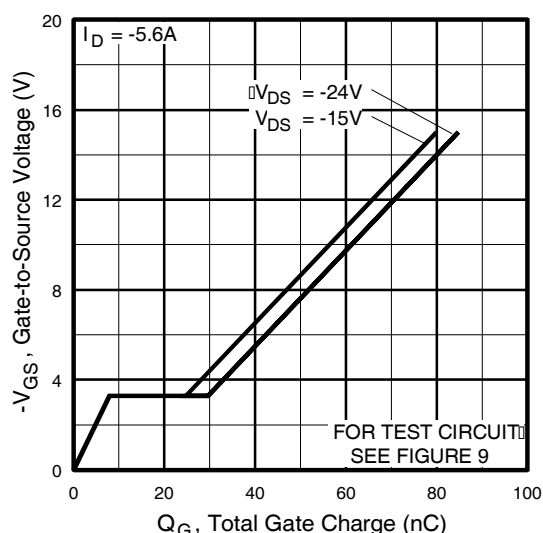
④ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .

⑤ Surface mounted on FR-4 board,  $t \leq 10sec$ .

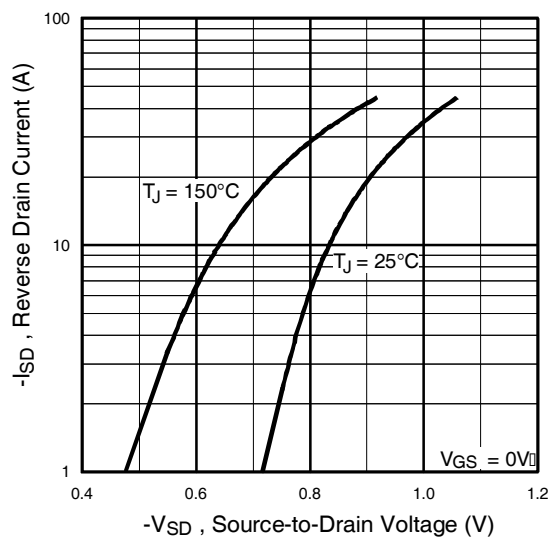

**Fig 1.** Typical Output Characteristics

**Fig 2.** Typical Output Characteristics

**Fig 3.** Typical Transfer Characteristics

**Fig 4.** Normalized On-Resistance Vs. Temperature



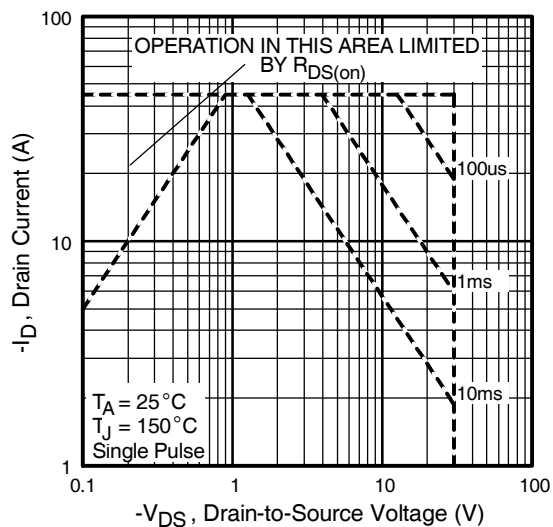
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



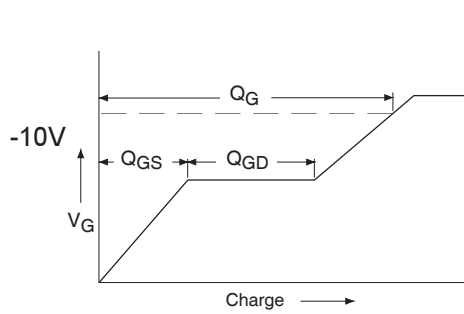
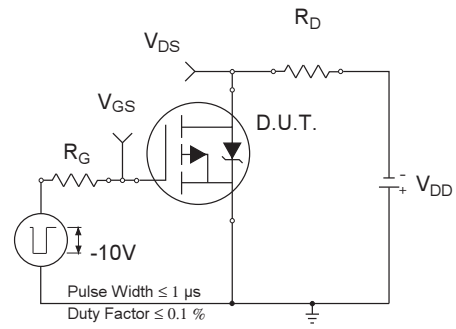
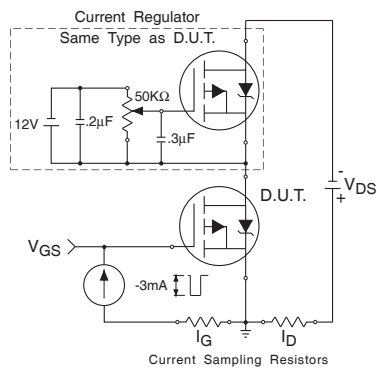
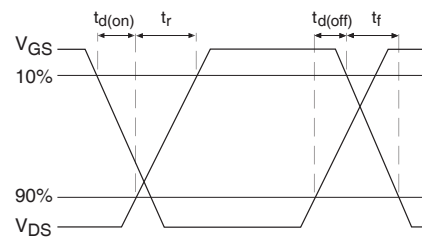
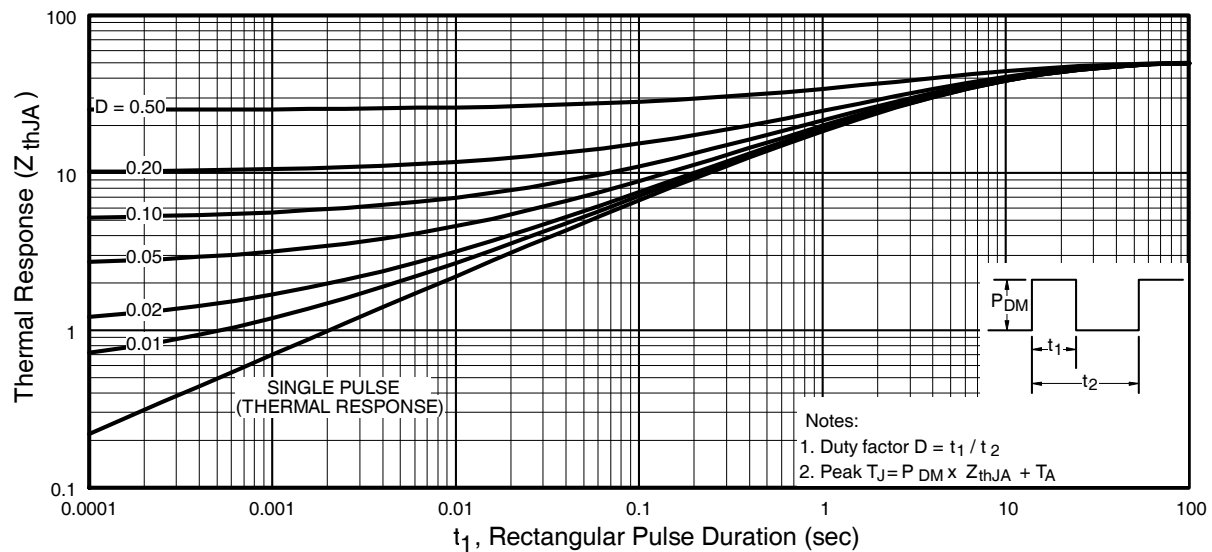
**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

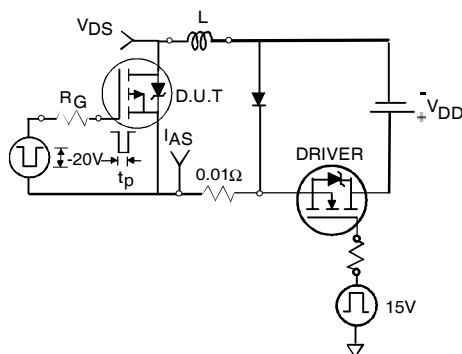
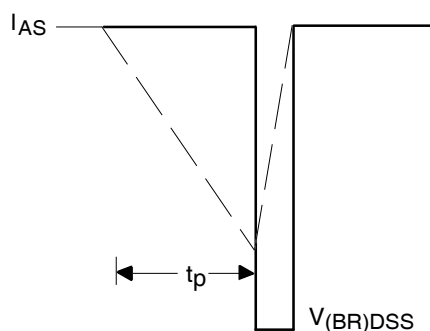
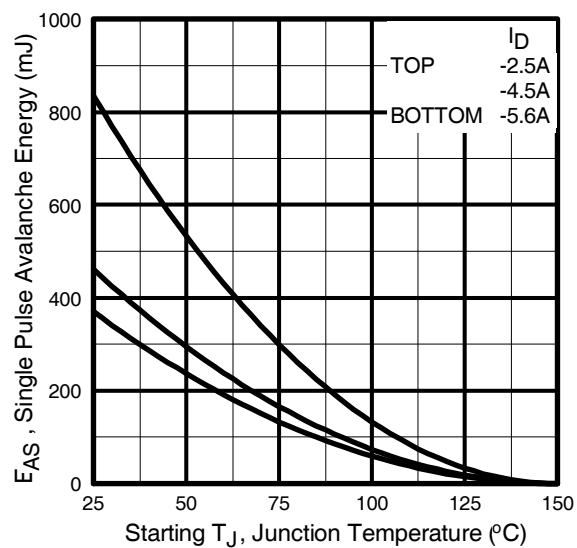


**Fig 7.** Typical Source-Drain Diode Forward Voltage

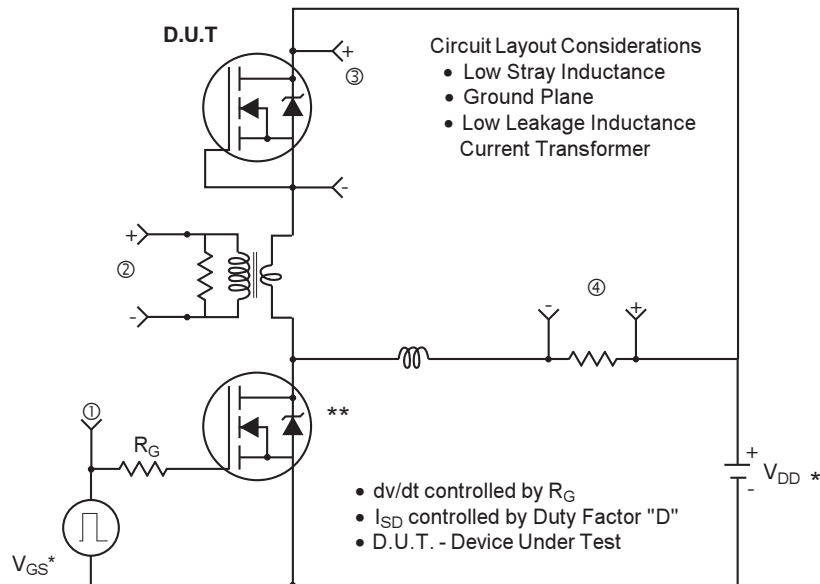


**Fig 8.** Maximum Safe Operating Area


**Fig 9a. Basic Gate Charge Waveform**

**Fig 10a. Switching Time Test Circuit**

**Fig 9b. Gate Charge Test Circuit**

**Fig 10b. Switching Time Waveforms**

**Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**

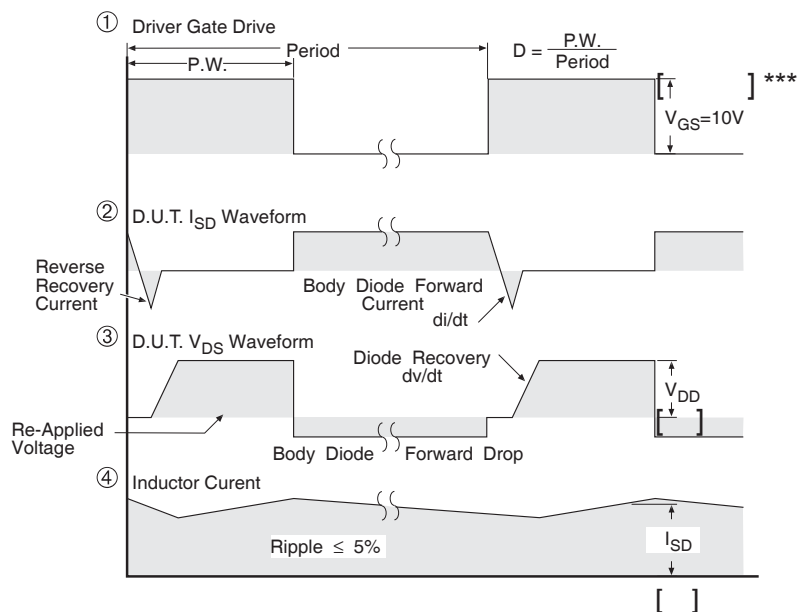

**Fig 12a.** Unclamped Inductive Test Circuit

**Fig 12b.** Unclamped Inductive Waveforms

**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

# Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity for P-Channel

\*\* Use P-Channel Driver for P-Channel Measurements

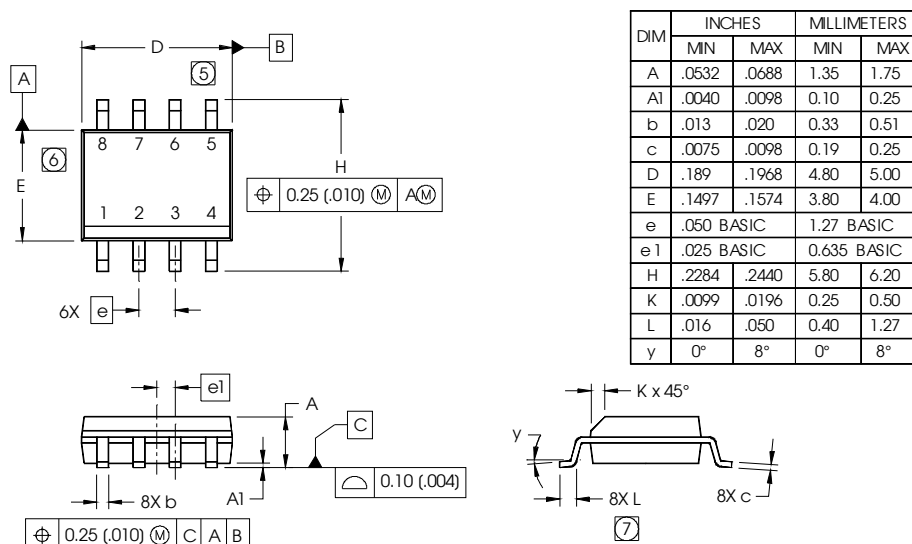


\*\*\*  $V_{GS} = 5.0V$  for Logic Level and 3V Drive Devices

**Fig 13. For P-Channel HEXFETS**

## SO-8 Package Outline

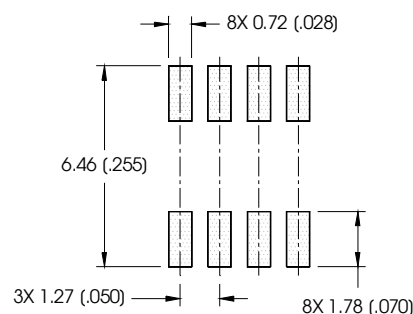
Dimensions are shown in millimeters (inches)



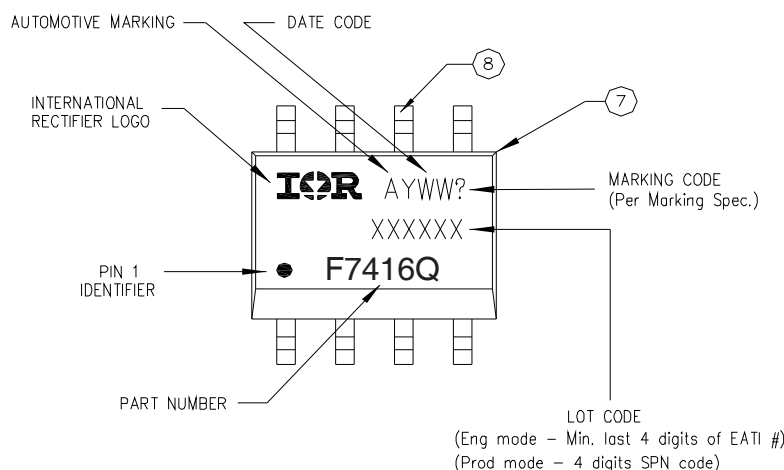
### NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- ⑤ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- ⑥ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- ⑦ DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

### FOOTPRINT



## SO-8 Part Marking

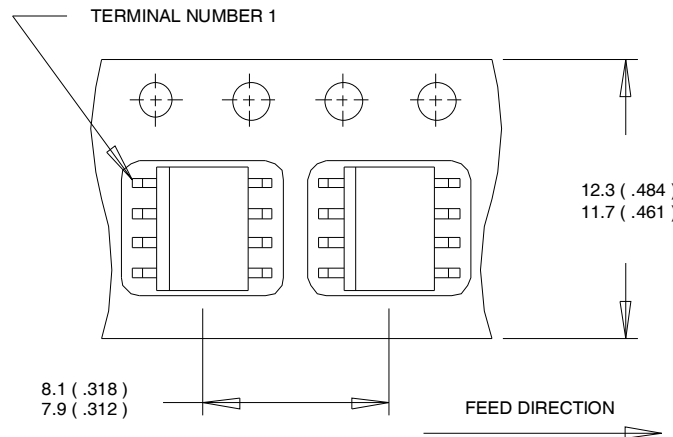


**Note:** For the most current drawing please refer to IR website at <http://www.irf.com/package/>



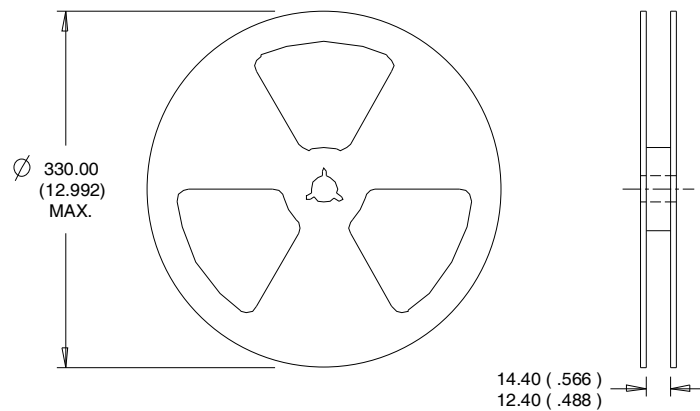
## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



### NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



### NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

**Note:** For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q101) <sup>††</sup>	
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
<b>Moisture Sensitivity Level</b>		SO-8	MSL1
<b>ESD</b>	Machine Model	Class M4 (+/- 425V) <sup>†††</sup> AEC-Q101-002	
	Human Body Model	Class H1B (+/- 1000V) <sup>†††</sup> AEC-Q101-001	
	Charged Device Model	Class C5 (+/- 1125V) <sup>†††</sup> AEC-Q101-005	
<b>RoHS Compliant</b>		Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/>

<sup>††</sup> Exceptions to AEC-Q101 requirements are noted in the qualification report.

<sup>†††</sup> Highest passing voltage.

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 Tel: (310) 252-7105

# Revision History

Date	Comments
3/27/2014	<ul style="list-style-type: none"> <li>• Added "Logic Level Gate Drive" bullet in the features section on page 1</li> <li>• Updated data sheet with new IR corporate template</li> </ul>

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